

OUT NOW - OUR NEW HTA - High Tensile Alloys & Battery Foil Sample Kit -PLEASE CONTACT US!



The following material specifications are available:

Mark	Materials	Dimension	Surface qualities	Material No.
A	Oxygenfree copper SE-Cu58 (C103)	0.010 x 250 mm	Plain – lamination quality (standard degreased)	145547
В	Oxygenfree copper SE-Cu58 (C103)	0.010 x 250 mm	Plain – electrolytically degreased (enhanced degreasing)	145546
D	High Tensile Copper Alloy HTA-520	0.010 x 250 mm	Plain – lamination quality (standard degreased)	148050
E	High Tensile Copper Alloy HTA-520	0.010 x 250 mm	Plain – electrolytically degreased (enhanced degreasing)	148051
J	High Tensile Copper Alloy HTA-750	0.010 x 250 mm	Plain – lamination quality (standard degreased)	153143
к	High Tensile Copper Alloy HTA-750	0.010 x 250 mm	Plain – electrolytically degreased (enhanced degreasing)	153144
М	High Tensile Copper Alloy HTA-600	0.010 x 250 mm	Plain – lamination quality (standard degreased)	159338
Ν	High Tensile Copper Alloy HTA-600	0.010 x 250 mm	Plain – electrolytically degreased (enhanced degreasing)	159339
0	Tin clad Copper SE-Cu Copper	0.010 x 250 mm	Tin clad on both sides with Sn 100 – hard as rolled	160833
Р	Alu/Copper composite Foil	0.035 x 250 mm	Aluminum one side copper clad thickness ratio: 70/30	162676
F	Nickel 99.6 (N201)	0.010 x 250 mm	Plain – lamination quality (standard degreased)	158954
G	Nickel 99.6 (N201)	0.010 x 250 mm	Plain – electrolytically degreased (enhanced degreasing)	159611

Data in this publication is based on careful investigations and is intended for information only. All information shall not be binding, shall carry no warranty as to certain ingredients, as to the fitting for a special purpose, as to the merchantability, or as to the industrial property rights of third parties. Any and all users are obliged to carry out tests on their own authority as well as to check the suitability and the danger of the respective product for a particular application. SCHLENK assumes no liability in this regard; neither to the exactness nor to the completeness of the data. We apply our General Sales Conditions to be found on <u>www.schlenk.com</u> Date: 03.01.24

RELATED PRODUCTS

Please consider also our advanced foil surfaces for Li metal application and tab ribbon:

- Ultra-low surface roughness <50nm used for CVD processes and Flexible Copper Clad Laminates (FCCL) for high frequency applications
- Ultra-thin foils from 0.006 mm (6μm) to 0.080 mm thickness
- Tab Ribbon made from Copper, Silver, Nickel and their alloys

For further information please visit our website: www.schlenk.com or contact our Area Sales Manager or your local representative. E-Mail contact: <u>battery@schlenk.com</u>

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